

# **Enhancement Mode N-Channel Power MOSFET**

 $TO-220F/NMOS/30V/\pm20V/1.8V/100A/3.1m\Omega$ 

Rev<sub>0.5</sub>



I<sub>D</sub> Max.

100A

 $R_{DS(on)}$  Typ.

 $3.1 m\Omega$  @ 10V

5.7mΩ @ 4.5V



### **Enhancement Mode N-Channel Power MOSFET**

 $V_{\text{DS}}$ 

30V

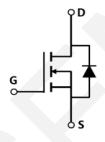
#### 1.Features

- ◆ Fast Switching
- ◆ Improved dv/dt Capability

### 2.Applications

- ◆ Load Switch
- PWM Application
- Power management





Pin Description

TO-220F

Schematic Diagram

### 3. Package Marking and Ordering Information

Part no.	Marking	Package	PCS/Tube	PCS/CTN.	
WP30100AFA	WP30100A	TO-220F	50	5,000	

### 4.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Value	Units
Drain to Source Voltage	V <sub>DS</sub>	30	V
Gate to Source Voltage	V <sub>GS</sub>	±20	V
Drain Current (DC)		100	А
Drain Current (Pulse), PW≤300μs	I <sub>DP</sub>	400	А
Total Dissipation	P <sub>D</sub>	78	W
Avalanche Energy, Single Pulsed	Eas	82	mJ
Junction Temperature	Tj	150	°C
Storage Temperature	$T_{stg}$	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



### 5. Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Junction to case	Rejc	1.6	°C/W
Junction to ambient	Reja	42	°C/W

Note 2: When mounted on 1 inch square copper board t ≤ 10sec The value in any given application depends on the user's specific board design.

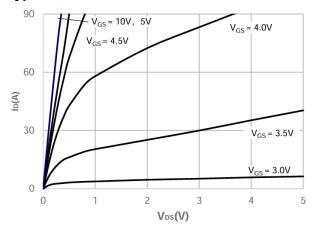
### 6.Electrical Characteristics at Ta=25°C (Note 3)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$I_D = 250 \mu A$ , $V_{GS} = 0 V$	30	-	-	V
Zero-Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V	ı	-	1	μA
Gate to Source Leakage Current	Igss	$V_{GS} = \pm 20V, V_{DS} = 0V$	1	-	±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250µA	30 1.0 1.8 - 3.1 - 5.7 - 2264 - 302	1.8	2.5	V
static Drain to Source On-State Resistance	-	I <sub>D</sub> = 30A, V <sub>GS</sub> = 10V	-	3.1	4.0	mΩ
	R <sub>DS(on)</sub>	$I_D = 20A, V_{GS} = 4.5V$	-	5.7	7.0	mΩ
Input Capacitance	Ciss	V <sub>GS</sub> =0V,	-	2264	-	pF
Output Capacitance	Coss	V <sub>DS</sub> =15V,	-	302	-	pF
Reverse Transfer Capacitance	Crss	Frequency=1.0MHz	-	246	-	pF
Turn-ON Delay Time	t <sub>d(on)</sub>		-	9	-	ns
Rise Time	tr	V <sub>GS</sub> =10V,	-	19	-	ns
Turn-OFF Delay Time	t <sub>d(off)</sub>	$V_{DS} = 15V, I_{D} = 30A,$ $R_{G} = 3\Omega$	-	37	-	ns
Fall Time	t <sub>f</sub>		-	13	-	ns
	Qg	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0 to 10V,	-	44	-	nC
Total Gate Charge	Qgs		-	9	-	nC
	$Q_{gd}$	I <sub>D</sub> = 30A	-	11	-	nC
Diode Forward Voltage	V <sub>FSD</sub>	I <sub>S</sub> = 30A, V <sub>GS</sub> = 0	0.5	-	1.2	V

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



### 7. Typical electrical and thermal characteristics



16

12

T<sub>J</sub> = 125°C

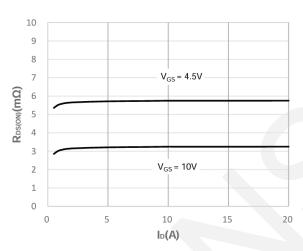
T<sub>J</sub> = -55°C

T<sub>J</sub> = -55°C

T<sub>J</sub> = 25°C

Ves(V)

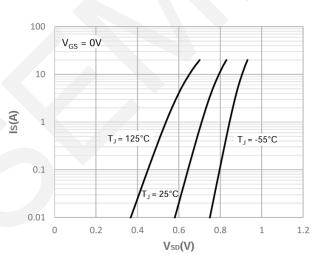
### **On-Region Characteristics**



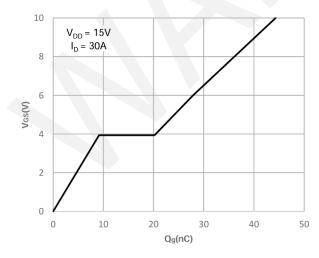
**Transfer Characteristics** 

20

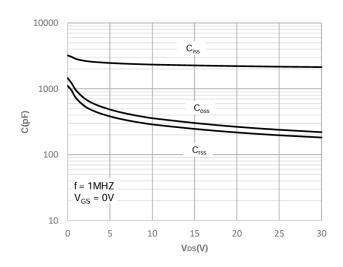
 $V_{DS} = 5V$ 



# On-Resistance vs. Drain Current and Gate Voltage



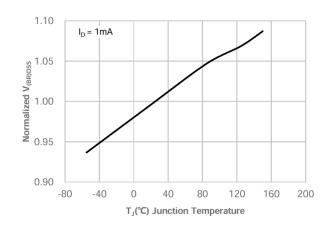
**Body Diode Characteristics** 

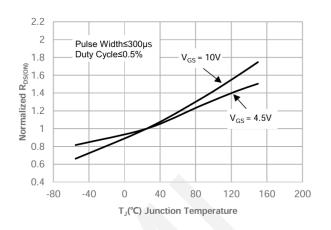


**Gate Charge Characteristics** 

**Capacitance Characteristics** 

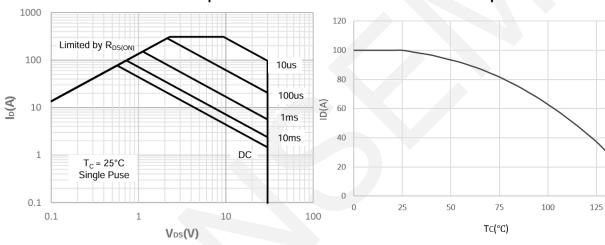






## Normalized Breakdown voltage vs. Junction Temperature

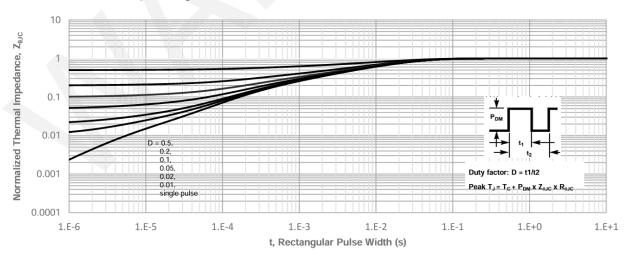
### Normalized on Resistance vs. Junction Temperature



### **Maximum Forward Biased Safe**

### **Current De-rating**

### **Operating Area**

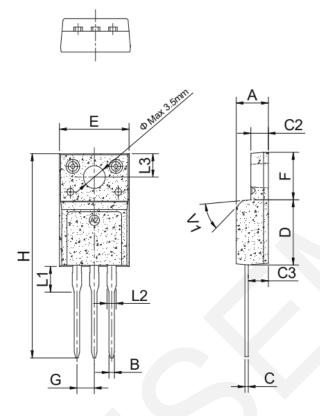


### Normalized Maximum Transient Thermal Impedance

150



### 8.Package Dimensions



	Dimensions					
Ref.	Millimeters				Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.50		4.90	0.177		0.193
В	0.74	0.80	0.83	0.029	0.031	0.033
С	0.47		0.65	0.019		0.026
C2	2.45		2.75	0.096		0.108
С3	2.60		3.00	0.102		0.118
D	8.80		9.30	0.346		0.366
E	9.80		10.4	0.386		0.410
F	6.40		6.80	0.252		0.268
G		2.54			0.1	
Н	28.0		29.8	1.102		1.173
L1		3.63			0.143	
L2	1.14		1.70	0.045		0.067
L3		3.30			0.130	
V1		45°			45°	



### 9. Important Notice

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